Atty. Docket No.: 42P17767

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Keith D. Jones

Application No: 10/750,491

Filed: December 31, 2003

Improved materials For Electronic For:

Devices

Examiner: Sheila V. Clark

Art Unit: 2823

Confirmation No.: 1802

Mail Stop: Amendment Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

Enclosed is a copy of Information Disclosure Citation Form PTO-1449 or PTO/SB/08 together with copies of the documents cited on that form, except for copies not required to be submitted (e.g., copies of U.S. patents and U.S. published patent applications need not be enclosed). It is respectfully requested that the cited documents be considered and that the enclosed copy of Information Disclosure Citation Form PTO-1449 or PTO/SB/08 be initialed by the Examiner to indicate such consideration and a copy thereof returned to applicant(s).

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Applicant would like to bring the following to the Examiner's attention:

Advanced substrates for electronic packaging used build up layers to allow the routing densities necessary for high I/O and power devices. These build up layers typically have CTE values substantially higher than that of the Cu traces and of the X-Y plane CTE of their core materials. This CTE mismatch leads to high stresses in these BU layers, leading to failures such as delamination, corner via cracking, et al.

Most BU materials consists of a photo-sensitive dielectric such as epoxy filled with Silica particles. The volume fraction of Silica particles will determine the effective CTE of the binder, with a higher volume fraction causing a lower CTE. This lower CTE is balanced, however, by the increase in viscosity of the binder, with recent attempts to lower the effective CTE of the BU materials has consisted of using different types of binder materials or modifiers, including polyolefins and rubber particulates. Other filler materials such as aramid short fibers have been uses as well.

A build up layer is known in the art of electronic packaging to allow routing densities necessary for high I/O, by isolating layers of conductive material disposed on a core of a substrate, to effect space transformation from the semiconductor die (relatively small, contact, and dense) through a substrate (a relatively larger grid) to a system contact (BGA, LGA, etc).

Pursuant to 37 C.F.R. § 1.97, the submission of this Information

Disclosure Statement is not to be construed as a representation that a search

has been made and is not to be construed as an admission that the information

cited in this statement is material to patentability.

10/750.491 - 2 - LJV/cak (10/27/04)

Pursuant to 37 C.F.R. § 1.97, this Information Disclosure Statement is being submitted under one of the following (as indicated by an "X" to the left of the appropriate paragraph):

 37	C.F.R.	§	1.97	'(b)
 37	C.F.H.	3	1.97	(r)

- X 37 C.F.R. §1.97(c). If so, then enclosed with this Information Disclosure Statement is one of the following:
 - ____ A statement pursuant to 37 C.F.R. §1.97(e) or
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- (1) A statement pursuant to 37 C.F.R. §1.97(e); and
- (2) A check for \$180.00 for the fee under 37 C.F.R. §1.17(p) for submission of the Information Disclosure Statement.

If there are any additional charges, please charge Deposit Account No. 02-2666.

Respectfully submitted,

BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN LLP

Dated: Jun 28, 2006

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Summary of USPTO Kind Codes Used on Documents Published Beginning January 2, 2001

WIPO ST.16 Kind Codes	Kind of document	Comments
A1	Patent Application Publication	Pre-grant publication available March 2001
A2	Patent Application Publication (Republication)	Pre-grant publication available March 2001
А9	Patent Application Publication (Corrected Publication)	Pre-grant publication available March 2001
B1	Patent	No previously published pre-grant publication
В2	Patent	Having a previously published pre-grant publication and available March 2001
C1, C2, C3	Reexamination Certificate	Previously used codes B1 and B2 are now used for granted Patents
E	Reissue Patent	No change
Н	Statutory Invention Registration (SIR)	No change
P1	Plant Patent Application Publication	Pre-grant publication available March 2001
P2	Plant Patent	No previously published pre-grant publication
Р3	Plant Patent	Having a previously published pre-grant publication and available March 2001
P4	Plant Patent Application Publication (Republication)	Pre-grant publication available after March 2001
P9	Plant Patent Application Publication (Corrected Publication)	Pre-grant publication available March 2001
S	Design Patent	No change

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STATEMENT BY APPLICANT (use as many sheets as necessary)			F 0 2 2000 55	First Named Inventor:		Keith D. Jones	
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			U.S. PATEN	T DOCUMENTS	3		
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Substitute for Form 1449/PTO Complete if Known **Application Number** 10/750,491 INFORMATION DISCLOSURE Filing Date 12-31-2003 STATEMENT BY APPLICANT First Named Inventor: Keith D. Jones (use as many sheets as necessary) **Art Unit** 2823 **Examiner Name** Clark, Sheila V. Attorney Docket Number 42P17767 **Sheet** 2 of NON PATENT LITERATURE DOCUMENTS T² Examiner Cite Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue Initials* No number(s), publisher, city and/or country where published Discussion within the present Information Disclosure Statement. GAIL, R., "Breakthrough ceramic can take the heat" pp. 3, Electronic Engineering Times, May 20, 1996. EVANS, J.S.O., et al. "Negative thermal expansion materials", pp. 1 Abstract, www.ei.org/ (2001). CHANG, W., Technical Literature, "Zirconium Tungstate" pp. 17, printed on December 10, 2001. PEROTTONI, et al., "Pressure-induced amporhization and negative thermal expansion in Zr2W208" Science, May 8, 1998, v280 n5365 p886(4), pp. 4, http://web2.insite2.gale.com/ ANONYMOUS, "Zirconium Tungstate Behavior Explained" High Tech Ceramics News, April 1, 1997 v8 i12 pN/A, pp. 2. ANONYMOUS, "OPTOELECRONICS: Zirconium Tungstate Behvior Explained" Optical materials & Engineering News, February 1, 1997 v7 i6 pN/A, pp. 2 EVANS, et al., "Compressibility, phase transitions, and oxygen migration in zirconium tungstate, ZrW208" Science, January 3, 1997, v275 n5296 p61 (5), pp.6. ANONYMOUS, "Ceramic in wonderland: materials science" The Economist (US), April 27, 1996 v339 n7963 p88(2), pp. 2. ANONYMOUS, "Zirconium Tungstate Intrigues Researchers" New Technology Week, April 15, 1996 v10 i16 pN/A, pp. 1. ANONYMOUS, "Introducing the incredible shrinking ceramic..." New Scientist, April 13, 1996, p17, pp. 2.

Examiner	Date
Signature	Considered

MARY, et al., "Negative thermal expansion form 0.3 to 1050 Kelvin in ZrW208" Science,

April 5, 1996, v272 n5258 p90(3), pp. 5

^{*}Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹Applicant's unique citation designation number (optional). ²Applicant is to place a check mark here if English Translation is attached.

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